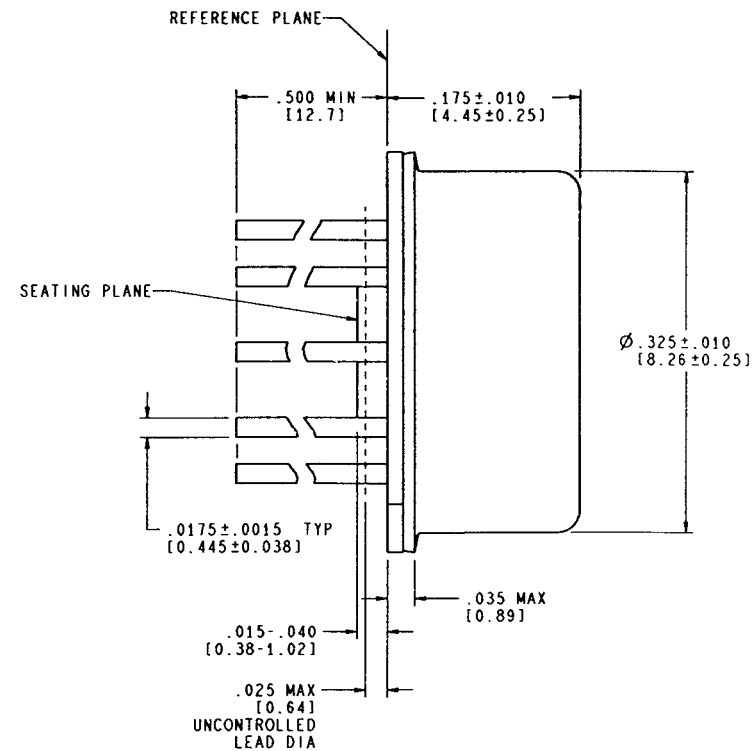
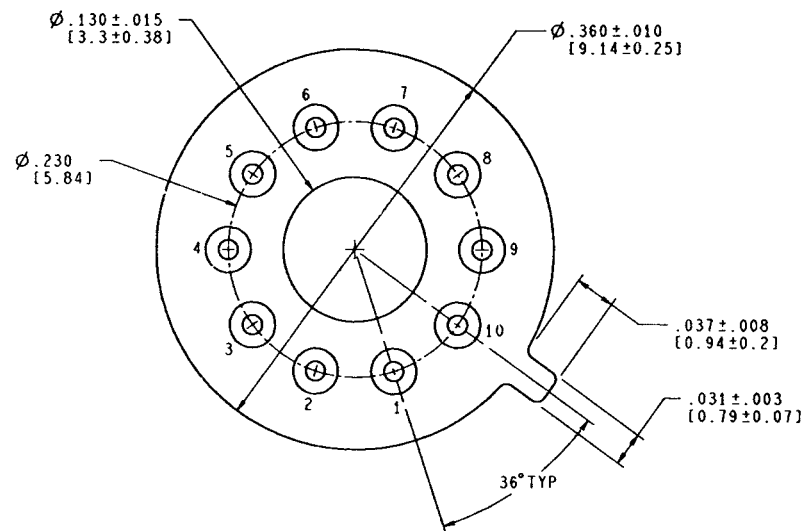


REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
F	REVISE & REDRAW PER CURRENT STANDARD: UPDATE MIL/AERO STAMP & TITLE.	11003	06/26/95	MS/df



CONTROLLING DIMENSION IS INCH
VALUES IN {} ARE MILLIMETERS

**MIL-I-38535
CONFIGURATION CONTROL**

NOTES: UNLESS OTHERWISE SPECIFIED

1. LEADS TO BE LOCATED WITHIN .007 IN/ 0.18 mm OF THEIR TRUE POSITIONS RELATIVE TO A MAXIMUM WIDTH TAB.
2. STANDARD METAL CAN TYPE: SOLID BASE WITH CERAMIC STANDOFF.
3. APPLIES TO MIL-AERO AND LINEAR PRODUCTS.
4. REFERENCE JEDEC REGISTRATION TO-100, JEDEC PUBLICATION No.95.

APPROVALS		DATE		National Semiconductor 2900 Semiconductor dr., Santa Clara, CA 95052-8090	
DRAWN MARTA SUCHY		06/26/95			
DFTG. CHG. Thom Loxeang		6/27/95		METAL CAN, TO-100, 10 LEAD, .230 DIA P.C.	
ENGR. CHG. Jeffery J. Smith		6/27/95			
PROJECTION 		SCALE N/A	SIZE C	DRAWING NUMBER MKT-H10C	REV F
DO NOT SCALE DRAWING				SHEET 1 of 1	